

March 2013

FDPF10N60ZUT N-Channel UniFETTM II Ultra FRFETTM MOSFET 600 V, 9 A, 0.8 Ω

Features

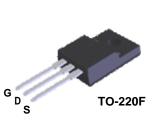
- $R_{DS(on)} = 650 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$
- Low Gate Charge (Typ. 31 nC)
- Low C_{rss} (Typ. 15 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- RoHS Compliant

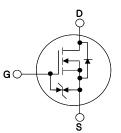
Applications

- LCD/LED/PDP TV
- Lighting
- Uninterruptible Power Supply

Description

UniFETTM II MOSFET is Fairchild Semiconductor[®]'s high voltage MOSFET family based on planar stripe and DMOS technology. This MOSFET is tailored to reduce on-state resistance, and to provide better switching performance and higher avalanche energy strength. UniFETTM II Ultra FRFETTM MOSFET has much superior body diode reverse recovery performance. Its t_{rr} is less than 50nsec and the reverse dv/dt immunity is 20V/nsec while normal planar MOSFETs have over 200nsec and 4.5V/ nsec respectively. Therefore UniFET Ultra FRFET MOSFET can remove additional component and improve system reliability in certain applications that require performance improvement of the MOSFET's body diode. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter			FDPF10N60ZUT	Unit
V _{DSS}	Drain to Source Voltage			600	V
V _{GSS}	Gate to Source Voltage			±30	V
ID	Drain Current	- Continuous ($T_C = 25^{\circ}C$)		9*	Α
		- Continuous ($T_C = 100^{\circ}C$)		5.4*	
I _{DM}	Drain Current	- Pulsed	- Pulsed (Note 1)		Α
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	100	mJ
I _{AR}	Avalanche Current		(Note 1)	9	A
E _{AR}	Repetitive Avalanche Energy		(Note 1)	18	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20	V/ns
P _D	Power Dissipation	$(T_{C} = 25^{\circ}C)$		42	W
		- Derate above 25°C		0.3	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C

Thermal Characteristics

Symbol	Parameter	FDPF10N60ZUT	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.0	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/vv

Device Ma	arking	Device	Package	Reel Size	Таре	Width		Quantity	
FDPF10N60ZUT		FDPF10N60ZUT	TO-220F	•		-		50	
Electrica	I Chai	racteristics T _C = 25	^o C unless oth	erwise noted	-1				
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristic	S				I		I	1
BV _{DSS}	Drain t	o Source Breakdown Volta		= 250μA, V _{GS} = 0V, T _J =	25°C	600	-	-	V
ΔBV _{DSS} ΔT _{.1}	Breakd	eakdown Voltage Temperature befficient		$= 250 \mu A$, Referenced to		-	0.8	-	V/ºC
			V	_{DS} = 600V, V _{GS} = 0V		-	-	25	
IDSS	∠ero G	ate Voltage Drain Current	V	$_{DS} = 480V, T_{C} = 125^{\circ}C$		-	-	250	μΑ
I _{GSS}	Gate to Body Leakage Current			$_{GS} = \pm 30$ V, $V_{DS} = 0$ V		-	-	±10	μA
On Charac	teristic	S							
V _{GS(th)}	Gate T	Gate Threshold Voltage		_{GS} = V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}		Drain to Source On Resist		$_{GS} = 10V, I_{D} = 4.5A$		-	0.65	0.8	Ω
9FS	Forwar	d Transconductance	V	$_{DS} = 40V, I_{D} = 4.5A$		-	12.5	-	S
Dynamic C	haract	eristics	I	-	L				
C _{iss}		apacitance			-	1490	1980	pF	
C _{oss}	Output	It Capacitance		— V _{DS} = 25V, V _{GS} = 0V — f = 1MHz	-	230	240	pF	
C _{rss}	Revers	e Transfer Capacitance	1 = 1101112			-	15	25	pF
Q _{g(tot)}	Total G	ate Charge at 10V				-	31	40	nC
Q _{gs}	Gate to	to Source Gate Charge		$V_{DS} = 480V, I_{D} = 10A$		-	8	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge	V	V _{GS} = 10V (Note 4)		-	12	-	nC
Switching	Charac	teristics	H			1		1	
t _{d(on)}		Irn-On Delay Time				-	25	60	ns
t _r	Turn-O	n Rise Time		_{DD} = 300V, I _D = 10A	-	-	40	90	ns
t _{d(off)}	Turn-O	ff Delay Time	R	$_{ m G}$ = 25 Ω , V $_{ m GS}$ = 10V	F	-	95	200	ns
t _f	Turn-O	ff Fall Time		(Note 4		-	60	130	ns
Drain-Sou	rce Dio	de Characteristics			ŀ				
I _s	Maximum Continuous Drain to Source Diode Forward Current			-	-	9	A		
I _{SM}	Maximu	Maximum Pulsed Drain to Source Diode F		rd Current		-	-	36	Α
V _{SD}	Drain to	Source Diode Forward V	oltage V	_{GS} = 0V, I _{SD} = 10A		-	-	1.6	V
t _{rr}	Revers	e Recovery Time		_{GS} = 0V, I _{SD} = 10A		-	45	-	ns
Q _{rr}	Povoro	e Recovery Charge		dl _F /dt = 100A/μs	-	52	_	nC	

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 2mH, I_{AS} = 10A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^\circ\text{C}$

3. $I_{SD} \leq$ 10A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS}$, Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics



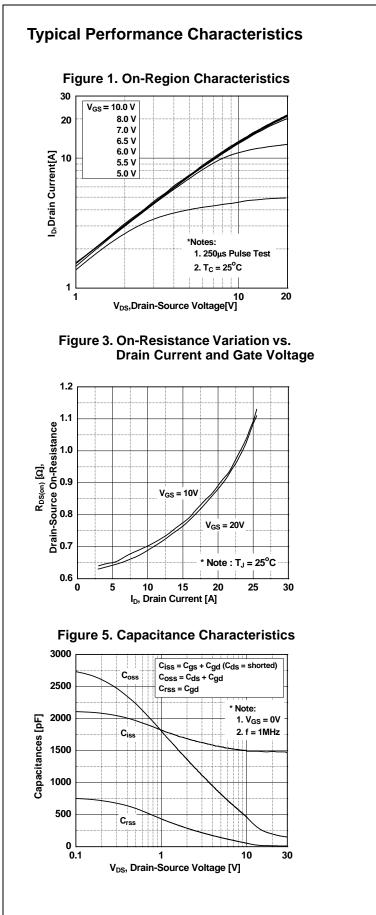


Figure 2. Transfer Characteristics

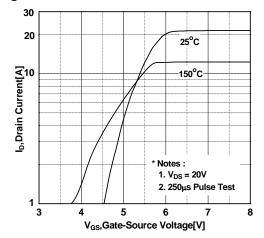


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

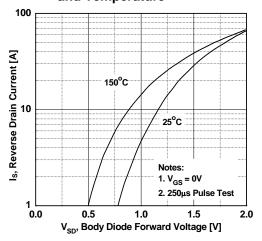
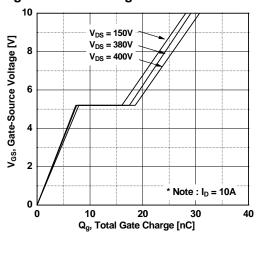
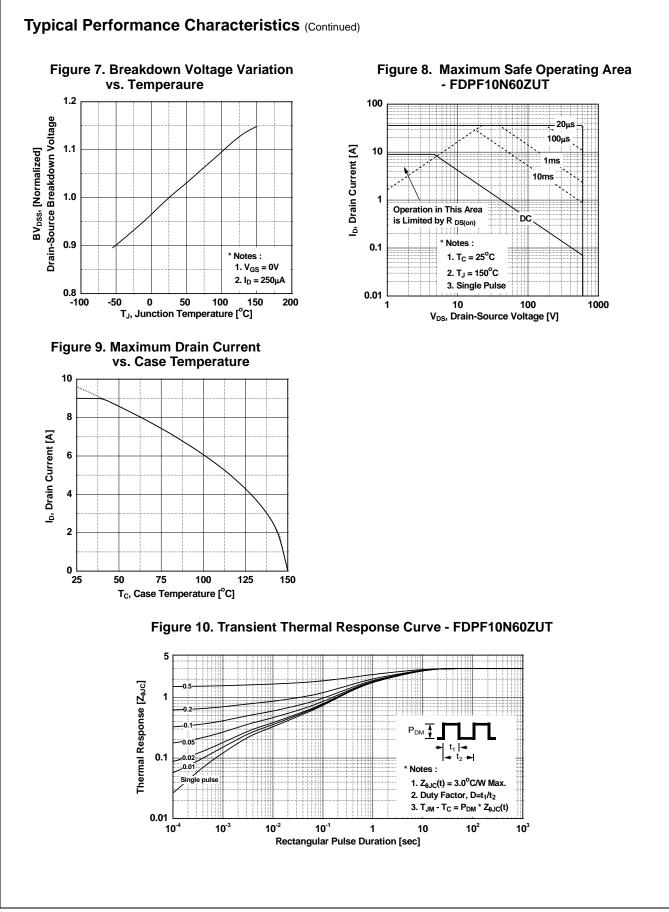
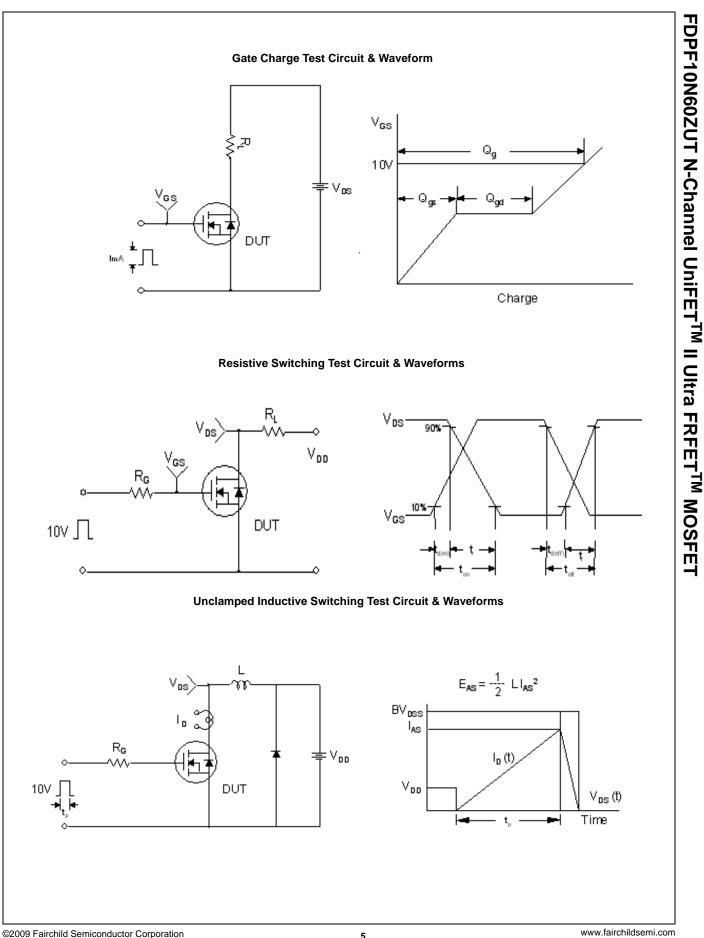


Figure 6. Gate Charge Characteristics

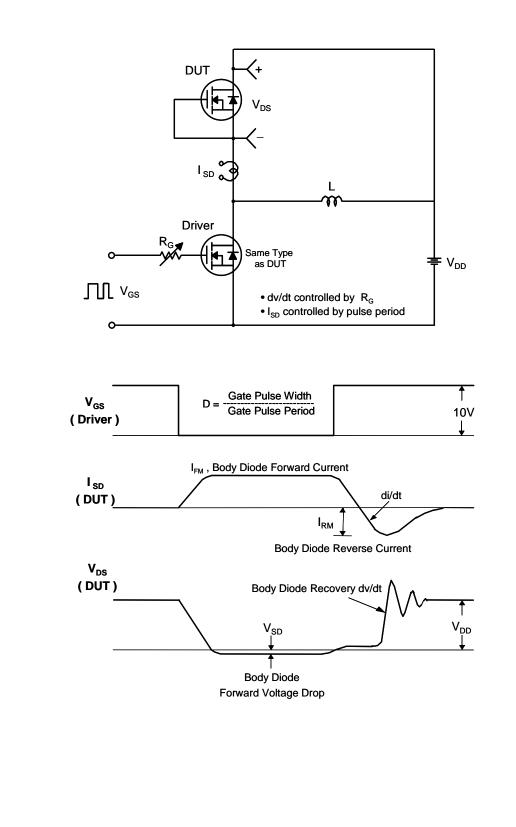


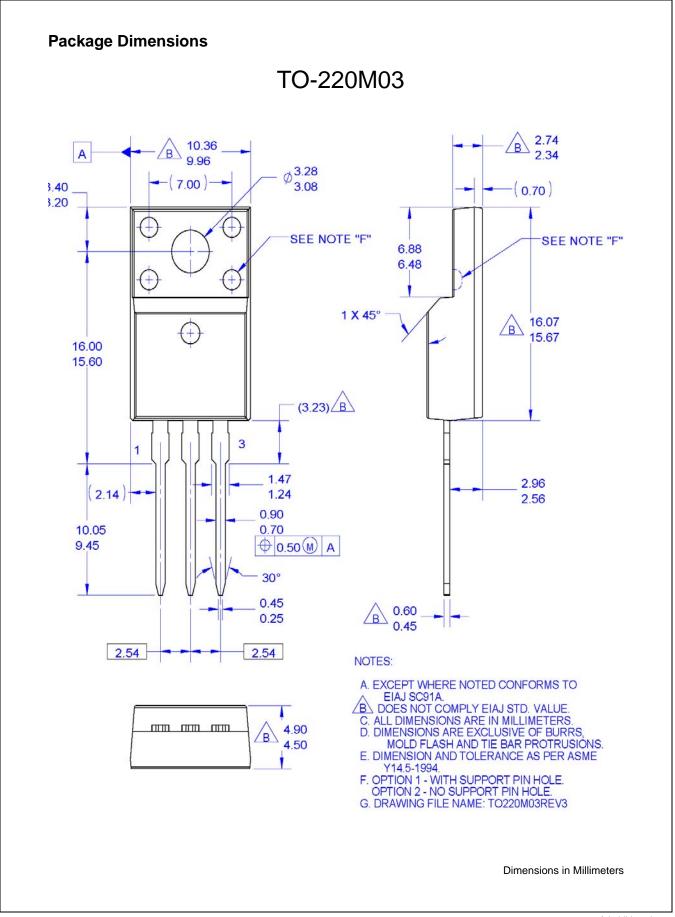




FDPF10N60ZUT Rev. C0

Peak Diode Recovery dv/dt Test Circuit & Waveforms







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